April 2001

FDS6672A

FAIRCHILD

30V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

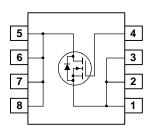
Applications

• DC/DC converter

Features

- 12.5 A, 30 V. $R_{DS(ON)} = 8 \ m\Omega @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 9.5 \ m\Omega @ V_{GS} = 4.5 \ V$
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low gate charge (33 nC typical)
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		30	V	
V _{GSS}	Gate-Source Voltage		±12	V	
I _D	Drain Current – Continuous	(Note 1a)	12.5	А	
	- Pulsed		50		
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W	
		(Note 1b)	1.2		
		(Note 1c)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	
Therma	I Characteristics			·	
P	Thermal Resistance Junction-to-Ambient	(Note 1a)	50	°C/M	

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6672A	FDS6672A	13"	12mm	2500 units

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 $T_{A} = 25^{\circ}C$ unless otherwise noted Min Units **Test Conditions** Тур Max Drain-Source Breakdown Voltage 30 V $V_{GS} = 0 V, I_D = 250 \mu A$ $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ 20 mV/°C $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ 1 μΑ $V_{GS} = 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ 100 nA $V_{GS} = -12 V V_{DS} = 0 V$ -100 nA 0.8 $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ V 1.2 2.0 $I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$ -4 mV/°C 6.8 8 mΩ 8.2 9.5 $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 12.5 \text{ A},$ 11.5 16 T_J=125°C $V_{GS} = 10 \text{ V}, \text{ } V_{DS} = 5 \text{ V}$ 50 А s $V_{DS} = 10 V$, $I_{D} = 15 \text{ A}$ 75 5070 pF $V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz550 pF 230 pF

Switching Characteristics (Note 2)

Input Capacitance

Output Capacitance

Dynamic Characteristics

Electrical Characteristics

Coefficient

Parameter

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

Gate-Body Leakage, Forward

Gate-Body Leakage, Reverse

Gate Threshold Voltage

Gate Threshold Voltage

Temperature Coefficient

On–State Drain Current

Forward Transconductance

Reverse Transfer Capacitance

Static Drain-Source

On-Resistance

(Note 2)

Symbol

BV_{DSS}

 ΔBV_{DSS}

 ΔT_{\perp} IDSS

I_{GSSF}

IGSSR

V_{GS(th)}

 $\Delta V_{GS(th)}$

 $\Delta T_{\rm J}$ R_{DS(on)}

I_{D(on)}

g_{FS}

 C_{iss}

Coss

 C_{rss}

Off Characteristics

On Characteristics

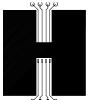
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t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V, I_D = 1 A,$	17	25	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5$ V, $R_{GEN} = 6 \Omega$	18	25	ns
$t_{d(off)}$	Turn–Off Delay Time		69	100	ns
t _f	Turn–Off Fall Time		29	42	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, \ I_D = 15 \text{ A},$	33	46	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 4.5 V	7.5		nC
Q _{gd}	Gate–Drain Charge		6.8		nC

Drain–Source Diode Characteristics and Maximum Ratings

Is	Maximum Continuous Drain–Source Diode Forward Current				2.1	А
V_{SD}	Drain–Source Diode Forward Voltage	$V_{GS}=0~V,~~I_S=2.1~A$	(Note 2)	0.7	1.2	V

Notes:

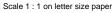
1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.





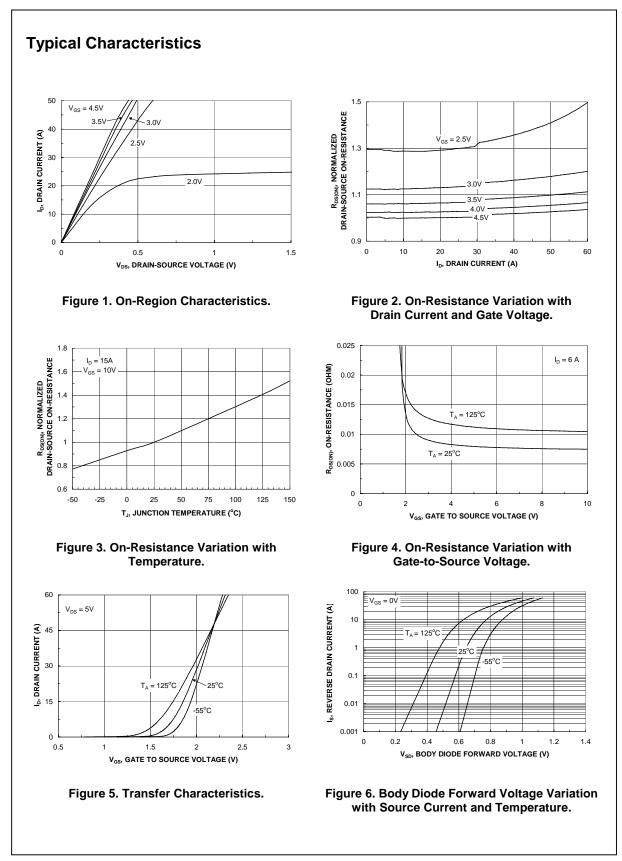
ωφφω b) 105°/W when mounted on a .04 in² pad of 2 oz copper

c) 125°/W when mounted on a minimum pad.

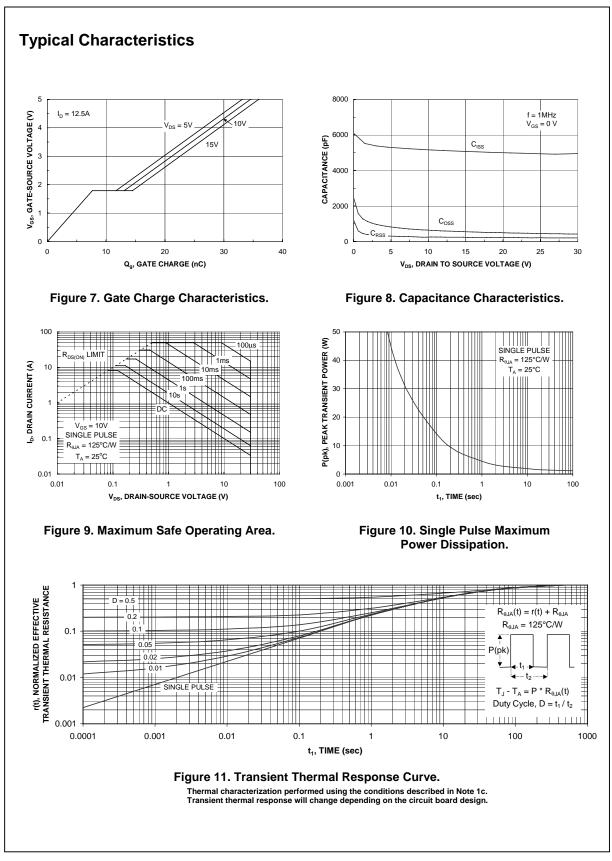


2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS6672A Rev C(W)



FDS6672A



FDS6672A

FDS6672A Rev C(W)

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